#### TOSHIBA Photocoupler GaAs IRED & Photo-MOSFET

# **TLP170D**

**PBX** 

Modem · Fax Card
Telecommunication
Security Equipment
Measurement Equipment

The Toshiba TLP170D consists of a gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a 4-pin SOP package. This photorelay requires 1 mA of LED current to turn it on. It is suitable for applications that need electrical power saving.

• SOP 4 pin (2.54SOP4): 1-Form-A

• Peak off-state voltage: 200 V (min)

• Trigger LED current: 1 mA (max)

• ON-state current: 200 mA (max)

• ON-state resistance:  $8 \Omega \text{ (max)}$ 

• Isolation voltage: 1500 Vrms (min)

• UL recognized: UL1577, file No. E67349

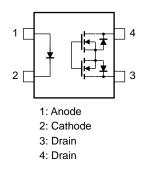
 ${\bf cUL}\ {\bf recognized:}\ {\bf CSA}\ {\bf Component}\ {\bf Acceptance}\ {\bf Service}$ 

No. 5A File No.E67349

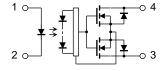
Option (V4) VDE approved: EN60747-5-5 (Note1)

(Note 1) When a VDE approved type is needed, please designate the "Option(V4)"

#### Pin Configuration (top view)



#### **Internal Circuit**



JEDEC —

JEITA —

TOSHIBA 11-5H1

Weight: 0.1 g (typ.)

Start of commercial production 2009-06

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
	Pulse forward current (100 μs pulse, 100 pps)	IFP	1	А
LED	Reverse voltage	VR	5	V
	Diode power dissipation	PD	50	mW
	Diode power dissipation derating (Ta ≥25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	Voff	200	V
	On-state current	I <sub>ON</sub>	200	mA
Detector	On-state RMS current derating (Ta $\geq$ 25°C)	Δl <sub>ON</sub> /°C	-2.0	mA/°C
	Output power dissipation	PC	300	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP <sub>C</sub> / °C	-3.0	mW/°C
	Junction temperature	Tj	125	°C
Storage temperature range		T <sub>stg</sub>	−55 to 125	°C
Operating temperature range		T <sub>opr</sub>	-40 to 85	°C
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Isolation vo	oltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1:Device considered a two-terminal device: pins1 and 2 shorted together and pins 3 and 4 shorted together.

## **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	-	-	160	V
Forward current	lF	_	2	25	mA
ON-state current	Ion	_	_	160	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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# **Individual Electrical Characteristics (Ta = 25°C)**

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	IR	$V_R = 5 V$	_	_	10	μΑ
	Capacitance	CT	V = 0 V, $f = 1 MHz$	_	30	_	pF
Detector	OFF-state current	loff	Voff = 200 V	_	1	1000	nA
	Capacitance	Coff	V = 0 V, f = 1 MHz		90	_	pF

## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	l <sub>FT</sub>	I <sub>ON</sub> = 200 mA	_	0.4	1	mA
Return LED current	IFC	IOFF = 100 μA	0.1	_	_	mA
On-state resistance	Ron	I <sub>ON</sub> = 200 mA, I <sub>F</sub> = 2 mA	_	5	8	Ω

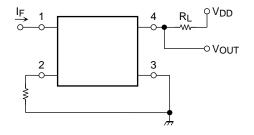
# **Isolation Characteristics (Ta = 25°C)**

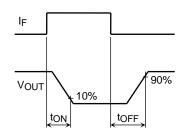
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation voltage	BVs	AC, 1 second, in oil	_	3000	_	VIIIIS
		DC, 1 minute, in oil	_	3000	-	Vdc

# **Switching Characteristics (Ta = 25°C)**

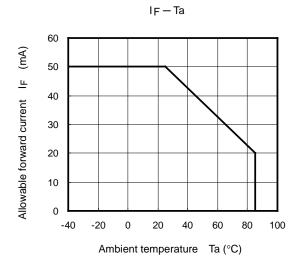
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$ \begin{array}{l} \text{R}_{L} = 200 \; \Omega \\ \text{V}_{DD} = 20 \; \text{V, I}_{F} = 2 \; \text{mA} \end{array} $ (Note2)	_	3.0	8.0	ms
Turn-on time	ton	$ \begin{array}{l} \text{R}_{L} = 200~\Omega \\ \text{V}_{DD} = 20~\text{V, I}_{F} = 5~\text{mA} \end{array} $ (Note2)	_	_	5.0	ms
Turn-off time	tOFF	$ \begin{array}{l} \text{R}_{L} = 200 \; \Omega \\ \text{V}_{DD} = 20 \; \text{V}, \; \text{I}_{F} = 2 \; \text{mA} \end{array} $ (Note2)	_	0.6	3.0	ms

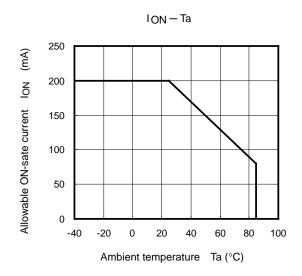
Note2: Switching time test circuit

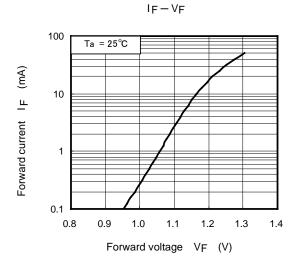


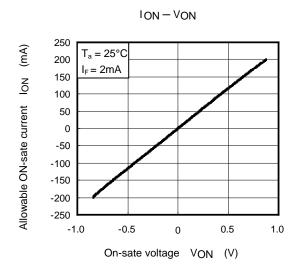


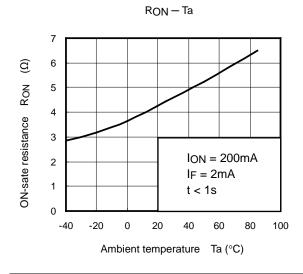
TLP170D

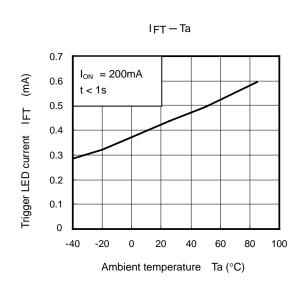


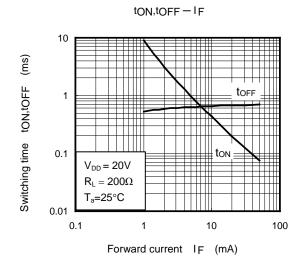


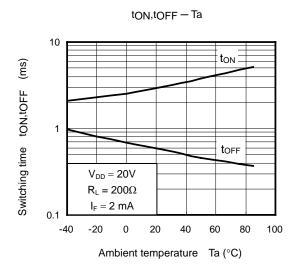


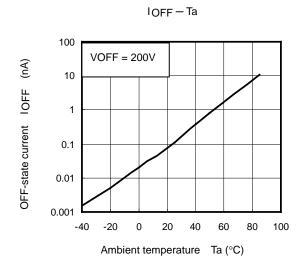












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